

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Packaging	Typical Dimension mm(inches)
1	IC1	1	—	TCR15AGADJ	TOSHIBA		WCSP6F	1.2 x 0.8
2	C1	1	1.0 μ F			Ceramic, 10V, \pm 10%	—	1.0 x 0.5 (0402)
3	C2	1	4.7 μ F			Ceramic, 10V, \pm 10%	—	1.6 x 0.8 (0603)
4	C3	1	10nF			Ceramic, 50V, \pm 10%	—	1.0 x 0.5 (0402)
5	C4	1	4.7 μ F			Ceramic, 10V, \pm 10%	—	1.6 x 0.8 (0603)
6	R1	1	Selectable			Ceramic, \pm 1%	—	1.0 x 0.5 (0402)
7	R2	1	Selectable			Ceramic, \pm 1%	—	1.0 x 0.5 (0402)

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